

MDT0096A2IS-SPI	80 x 160	SPI Interface	TFT Module					
	Specification							
Version: 1		Date: 01/10/2017						
		Revision						
1 2	9/09/2017	First issue						

Display F	eatures		
Display Size	0.96"		
Resolution	80 x 160		
Orientation	Portrait		
Appearance	RGB		
Logic Voltage	2.8V		oHS
Interface	SPI		
Brightness	350 cd/m ²		moliont
Touchscreen		1 00	mphant
Module Size	13.30 x 27.948 x 1.4mm		and a second
Operating Temperature	-20°C ~ +70°C		
Pinout	13 way FFC	Box Quantity	Weight / Display
Pitch	0.7mm		nnlv

* - For full design functionality, please use this specification in conjunction with the ST7735S specification.(Provided Separately)

Display Accessories					
Part Number	Description				

Optional Variants					
Appearances	Voltage				

General Description

This display module is a transmissive type color active matrix TFT(Thin Film Transistor liquid crystal display (LCD that uses amorphous silicon TFT as a switching device. This module is composed of a TFT LCD module, a driver circuit, and a back-light unit.The resolution of a 0.96" contains 80(RGB)X160 dots and can display up to 65k colors.

Features	Details	Unit
Display Size(Diagonal)	0.96	inch
LCD type	α-Si TFT	-
Display Mode	IPS / Transmissive / Normally Black	-
Resolution	80RGB x 160	-
View Direction	All	Best image
Module Outline	$13.3(H) \times 27.948(V) \times 1.4(T)$ (Note 1)	mm
TP Outline	N/A	mm
TP Viewing Area	N/A	mm
TP Active Area	N/A	mm
Active Area	10.80 (H)×21.70(V)	mm
Viewing Area	N/A	mm
Display Colors	65K	-
Interface	4-SPI	-
Driver IC	ST7735S	unnl y
Operating Temperature	-20~70	°C
Storage Temperature	-30~80	°C
Weight	TBD	g

Module Parameter

Note 1: Excluding hooks, posts, FPC/FPC tail etc.

Mechanical Drawings



Module Interface

NO	SYMBOL	FUNCTION
1	TP0	Touch Pin, If not used, please open this pin.
2	TP1	Touch Pin ,If not used, please open this pin.
3	SDA	SPI interface input/output pin. The data is latched on the rising edge of the SCL signal.
4	SCL	This pin is used to be serial interface clock.
5	D/C	Display data/command selection pin in 4-line serial interface.
6 RESET		This signal will reset the device and it must be applied to properly initialize the chip. Signal is active low.
7	CS	Chip selection pin; Low enable, High disable.
8	GND	Power Ground
9	NC	No Connect
10	VDD	Power Supply for Analog, VDD=2.5V~3.3V.
11	LEDK	LED Cathode
12	LEDA	LED Anode
13	GND	Power Ground
	desig	n • manufacture • supply

Application Circuit

4-Line SPI Interface



Note1: VIN=2.8V~5.5V.

Note2: EN pin signal control AW9364 working condition. When the EN pin signal is converted to high power, and the chip begins to work normally make it. AW9364 built-in shutdown delay circuit when EN pins letter switch from high level to low power and low level The delay of the shutdown of the chip is less than that of the die adjust the effect of LED output current size. When EN pins low electricity maintain time of more than 2ms, chip into shutdown mode.

Backlight recommended circuit

Motherboard driver backlight is need constant current circuit, if the rated voltage screen after light brightness difference.Current and power consumption of the machine are inconsistent, so recommend a backlight driving circuit is best rated current.It is recommended to use IC (AW9364). The reference circuit is as follows:



Note: constant current circuit for every LED, and though LED lamp current is less than 20mA.Recommand between 15mA and 20 mA for every LED.

Absolute Maximum Ratings

VSS=0V,	Ta=25°C
vbb 0v,	1a 25 C

I	tem	Symbol	Min.	Max.	Unit
	Power supply	VDD	-0.3	+4.6	V
Supply Voltage	Analog	-	-	-	V
	ΙΟ	IOVDD	-0.3	+4.6	V
Input Voltage	Input Voltage		-0.3	IOVDD+0.3	V
Storage temperature		T_{stg}	-30	+80	°C
Operating temperature		T_{op}	-20	+70	°C
Storage humidity		H_{stg}	10	Note 1	%RH
Operating humidity		H _{op}	10	Note 1	%RH

Note 1: 90%RH max, If Ta is below 50°C; 60%RH max, If Ta is over 60°C.

Electrical Specification

DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	
	Power supply	VDD	2.4	2.8	3.3	V
Supply Voltage	Analog	VCI	2.4	2.8	3.3	V
	ΙΟ	IOVDD	1.65	1.8/2.8	3.3	V
Logic Low input voltage	ge	VIL	-0.3IOVDD	-	0.3IOVDD	V
Logic High input volta	ge	V _{IH}	0.7IOVDD	-	IOVDD	V
Logic Low output volta	age 📃 🗆	V _{OL}		- 5	0.2IOVDD	V
Logic High output volt	age	VOH	0.8IOVDD	-	-	V
Comment Commention	Normal display	Ivdd	-	15	-	mA
Current Consumption	Standby mode	Ivdd	-	9	-	uA
Frame Frequency		f _{FR}	-	60	-	Hz

AC Characteristics

Reset timing and interface timing: Please refer to IC datasheet.

Command Table

Please refer to IC datasheet.

Recommended Setting and Initialization Flow for Reference

Please refer to attached file.

Optical Specifications

1. Optical Specifications

Ta=25°C, VDD=2.8V, TN LC+ Polarizer

	Itom		6ll	Condition	S	Specificatio	on	TI*4
	Item		Symbol	Condition	Min.	Тур.	Max.	Unit
	Luminance on surface($I_f = 15$ mA)		Lv	Normally viewing	300	350	-	cd/m ²
e)	Contrast ra	atio	CR	angle $\theta_x = \theta_y = 0^{\circ}$	-	600	-	-
Backlight On (Transmissive Mode)	Response t	ime	Tr	$\mathbf{O}_X - \mathbf{O}_Y - \mathbf{O}$	-	10	20	ma
ive N			T_F	-	-	20	30	ms
nissi	Chromaticity Transmissive	Red	Xr		0.614	0.644	0.674	-
ansı			Y _R		0.290	0.320	0.350	-
(Tr		Green Blue White	XG		0.270	0.300	0.330	-
t On			Y _G		0. <mark>54</mark> 0	0.570	0.600	-
light	Transmissive		XB	-	0.104	0.13 <mark>4</mark>	0.164	-
ack			Y _B		0.097	0.127	0.157	-
B			Xw		0.267	0.297	0.327	-
			Y_W	C.	0.302	0.332	0.362	-
	Viewing	Horiz	θx+	anutac	lu ne	80	upp	LY –
	Viewing Angle	ontal	θx-	Center	-	80	-	Пел
		Vertic	θ_{Y^+}	CR≥10	-	80	-	Deg.
		al	θγ-		-	80	-	
	NTSC Ratio(C	Gamut)	-	-	-	60	-	%

2. Definition of Response Time

2.1 Normally Black Type (Negative)



Tr is the time it takes to change form non-selected state with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

2.2 Normally White Type (Positive)



Tr is the time it takes to change form non-selected state with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	BM-7 or EQUI	
Measuring Point Diameter	3mm//1mm	
Measuring Point Location	Active Area centre point	
Test nottom	A: All Pixels white	
Test pattern	B: All Pixel black	
Contrast setting	Maximum	

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

4. Definition of Viewing Angles



Measuring machine: LCD-5100 or EQUI

5. Definition of Color Appearance

R,G,B and W are defined by (x, y on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7



6. Definition of Surface Luminance, Uniformity and Transmittance

Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.1 Surface Luminance: LV = average (LP1:LP9)
- 6.2 Uniformity = Minimal (LP1:LP9) / Maximal (LP1:LP9) * 100%
- 6.3 Transmittance = LV on LCD / LV on Backlight * 100%

Note :Measuring machine:BM-7



Quality Assurance

1. Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer by Midas display.

2. Agreement Items

Midas and customer shall negotiate if the following situation occurs:

2.1 Additional requirement to be added in product specification.

2.3 Any other special problem.

3. Standard of the Product Visual Inspection

3.1 Appearance inspection:

3.1.1 The inspection must be under illumination about 1000 - 1500 lx, and the distance of view must be at 30cm \pm 2cm.

3.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

3.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area.



3.2 Basic principle: A set of sample to indicate the limit of acceptable quality level must be discussed by both Midas and customer when there is any dispute happened.

4. Inspection Specification

Sampling plan according to GB/T2828.1-2012/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993,normal level 2 and based on:

Major defect: AQL 0.65 Minor defect: AQL 1.5

No.	Item	Criteria (Unit: mm)					
		a	Size	Area A	Acc. Qty		
	Black / White spot		φ≤0.10		Ignore		
	Foreign material	h	0.10<φ≤0.1	15	2		
01	(Round type)		0.15<φ≤0.2	20	1		
01	Pinholes Stain		0.20<φ		0		
	Particles inside cell. (Minor defect)	$\varphi = (a + b)/2$	Total		no include p≤ 0.10		
		Distance between	2 defects should more t	han Emma			
	Black and White line						
02	Scratch Foreign material	Length	Width	Acc. Qty			
	(Line type)	/	$W \leq 0.03$	Ignore			
	(Minor defect)	$L \leq 2$	$0.03 < W \le 0.05$	1			
		/	0.05 < W	0			
			Total	1			
			2 defects should more t vable through the back of	-			

No.	Item	Criteria (Unit: mm)			
03	Glass Crack (Minor defect)	LCD with extensible crack line is unacceptable(When press the cracked LCD area, the line will expand, we define it is extensible crack line)			
04	Glass Chipping Pad Area: (Minor defect)	Length and WidthAcc. Qty $c < 5.0, b < 0.4$ Ignore			
05	Glass Chipping Rear of Pad Area: (Minor defect)	Length and Width Acc. Qty $c > 3.0, b < 1.0$ 1 $c < 3.0, b < 1.0$ 2 $c < 3.0, b < 0.5$ 4 $a < Glass Thickness$ $a < Glass Thickness$			
06	Glass Chipping Except Pad Area: (Minor defect)	Length and WidthAcc. Qtyc ≤0.6, b< 5.0			

No.	Item	Criteria (Unit: mm)			
07	Glass Corner Chipping: (Minor defect)	Length and WidthAcc. Qty $c < 2.0, b < 1.5$ Ignore $c < 1.5, b < 2$ Ignore $a < Glass Thickness$			
08	Glass Burr: (Minor defect)	Glass burr don't affect assemble and module dimension.LengthAcc. Qty $F < 0.5$ Ignore			
09	FPC Defect: (Minor defect) $a \rightarrow b \rightarrow b$ $w \rightarrow b \rightarrow b$ $a \rightarrow b \rightarrow b$	 9.1 Dent, pinhole width a<w 3.<="" li=""> (w: circuitry width.) 9.2 Open circuit is unacceptable. 9.3 No oxidation, contamination and distortion. </w>			
10	Bubble on Polarizer (Minor defect)	$\begin{tabular}{ c c c c c c c } \hline Diameter & Acc. Qty \\ \hline \phi \le 0.10 & Ignore \\ \hline 0.1 < \phi \le 0.2 & 1 \\ \hline 0.2 < \phi & None \\ \hline \end{tabular}$			
11	Dent on Polarizer (Minor defect)	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$			
12	Bezel	12.1 No rust, distortion on the Bezel.12.2 No visible fingerprints, stains or other contamination.			

No.	Item	Criteria (Unit: mm)				
	Touch Panel	D: Diameter W: width L: length				
		13.1 Spot: D≤0.20 is acceptable				
		0.20 <d≤0.3, 3<="" acceptable="" qty,="" td=""></d≤0.3,>				
		2dots are acceptable and the distance between defects should more				
		than 10 mm.				
13		D>0.3 is unacceptable				
		13.2 Dent: D>0.30 is unacceptable				
		13.3 Scratch: W≤0.03, L≤10 is acceptable,				
		0.03 <w≤0.10, ,acceptable="" 3<="" l≤10="" qty,="" td=""></w≤0.10,>				
		Distance between 2 defects should more than 10 mm.				
		W>0.10 is unacceptable.				
	РСВ	14.1 No distortion or contamination on PCB terminals.				
14		14.2 All components on PCB must same as documented on				
		the BOM/component layout.				
		14.3 Follow IPC-A-600F.				
15	Soldering	Follow IPC-A-610C standard				
	Electrical Defect (Major defect)	The below defects must be rejected.				
		16.1 Missing vertical / horizontal segment,				
		16.2 Abnormal Display.				
		16.3 No function or no display.				
		16.4 Current exceeds product specifications.16.5 LCD viewing angle defect.				
		16.6 No Backlight.				
		16.7 Dark Backlight.				
16		16.8 Touch Panel no function.				
		16.9 Dark Dot –one Allowed.				
		16.10 Bright Dot – one Allowed.				
		Remark:				
		1. A pixel defect is acceptable if one color is none functional and				
		causes a bright dot. The display may have one case where one				
		color is out and cause a dark dot.				
		2. Bright dot caused by scratch and foreign object accords to item1.				
	Demontry Visual and accomptine defeate are anisatable antwifthese fall within the LCD visuaire.					

Remark: Visual and cosmetic defects are rejectable only if these fall within the LCD viewing area.

5. Classification of Defects

Visual defects (Except no / wrong label are treated as minor defect and electrical defect is major.

6. Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

- 7. Packing
- 7.1 There should be no damage of the outside carton box, each packaging box should has label in the correct location per packing drawing requirement.
- 7.2 All direct package materials shall offer ESD protection.

Reliability Specification

Item	Condition	Cycle Time	Quantity	Remark
Constant Temp. and Constant Humidity Operation Test	$+40 \pm 3^{\circ}C,90 \pm 3^{\circ}RH$	120hrs		*1
High Temp. Operation Test	$+70 \pm 3^{\circ}\mathrm{C}$	120hrs		
Low Temp. Operation Test	$-20 \pm 3^{\circ}\mathrm{C}$	120hrs		
Thermal Shock Test	-20 ± 3°C (30min) +70 ± 3°C (30min)	10cycles		
ESD Test(end product)	150pF, 330Ω, ±2KV, Contact 150pF, 330Ω, ±6KV, Air	10times	- upp	*2, *3
Vibration Test (for packaging)	Frequency: 10Hz to 55Hz to10Hz,Swing:1.5mm,time: X,Y,Z each 2H.	6hrs	One inner carton	*4

Note 1. For humidity test, DI water should be used.

Inspection Standard: Inspect after 1-2hrs storage at room temperature, the sample shall be free from the following defects:

- Air bubble in the LCD
- Seal Leakage
- Non-display
- Missing Segment
- Glass Crack
- IDD is greater than twice initial value.
- Others as per QA Inspection Criteria

Note 2. No defect is allowed after testing

The End Product ESD value is only indicative and depends on customer ESD

protection design for the whole system.

Note 3. ESD should be applied to LCD glass panel, not other areas (such as on IC and so on) IDD should be within twice initial value.

In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

Note 4. Only upon request.

Precautions and Warranty

1. Safety

1.1 The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

1.2 Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

2. Handling

2.1 Reverse and use within ratings in order to keep performance and prevent damage.

2.2 Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

3. Operation

3.1 Do not drive LCD with DC voltage

3.2 Response time will increase below lower temperature

3.3 Display may change color with different temperature

3.4 Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".

4. Static Electricity

4.1 CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.

4.2 The normal static prevention measures should be observed for work clothes and benches.

4.3 The module should be kept into anti-static bags or other containers resistant to static for storage.

5. Limited Warranty

5.1 Unless otherwise agreed between Midas and customer, Midas will replace or repair any of its LCD and LCM which Midas found to be defective electrically and visually when inspected in accordance with Midas Quality Standards, for a period of one year from date of shipment.

5.2 The warranty liability of Midas is limited to repair and/or replacement. Midas will not be responsible for any consequential loss.

5.3 If possible, we suggest you use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.

Prior Consult Matter

1. For Midas standard products, we keep the right to change material, process for improving the product property without prior notice to our customer.

2. For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.

3. If you have special requirement about reliability condition, please let us know before you start the test on our samples.

design • manufacture • supply